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L Number	Hits	Search Text	DB	Time stamp
2	47	"bond wafer" and SOI	USPAT;	2002/08/23
			US-PGPUB	10:25
3	1	((COP or "crystal originated particles") with (eliminated or	USPAT;	2002/08/23
		eliminating or reduced or reduce or reducing or eliminate)	US-PGPUB	10:25
		with (wafer or substrate)) and ("bond wafer" and SOI)		
1	22	(COP or "crystal originated particles") with (eliminated or	USPAT;	2002/08/23
		eliminating or reduced or reduce or reducing or eliminate)	US-PGPUB	10:26
		with (wafer or substrate)		